# TEXAS INSTRUMENTS

#### 查询 \*\$\*\*\* <sup>#</sup>4 \*\* C1G125-EP"供应商

### FEATURES

Controlled Baseline

- One Assembly/Test Site, One Fabrication Site

- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Supports 5-V V<sub>CC</sub> Operation
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 3.7 ns at 3.3 V
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

## **DESCRIPTION/ORDERING INFORMATION**

This bus buffer gate is designed for 1.65-V to 5.5-V  $V_{CC}$  operation.

The SN74LVC1G125 is a single line driver with a 3-state output. The output is disabled when the output-enable (OE) input is high.

This device is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### **ORDERING INFORMATION**

T <sub>A</sub>	PACKAGE <sup>(1)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
-40°C to 85°C	SOT (SC-70) – DCK	Reel of 3000	CLVC1G125IDCKREP	СМО	
–55°C to 125°C	SOT (SC-70) – DCK	Reel of 3000	CLVC1G125MDCKREP	СМО	

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

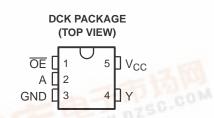
INPL	JTS	OUTPUT			
OE	Α	Y			
L	Н	н			
L	L	L			
Н	х	Z			

#### FUNCTION TABLE

SN74LVC1G125-EP SINGLE BUS BUFFER GATE WITH 3-STATE OUTPUT

SCES455B-DECEMBER 2003-REVISED JUNE 2006

- Low Power Consumption, 10- $\mu\text{A}$  Max I\_{CC}
- ±24-mA Output Drive at 3.3 V
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
    - 200-V Machine Model (A115-A)
    - 1000-V Charged-Device Model (C101)



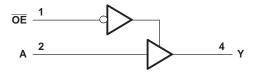


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## SN74LVC1G125-EP SINGLE BUS BUFFER GATE WITH 3-STATE OUTPUT

#### LOGIC DIAGRAM (POSITIVE LOGIC)



### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
$V_{CC}$	Supply voltage range	-0.5	6.5	V	
VI	Input voltage range <sup>(2)</sup>		-0.5	6.5	V
Vo	Voltage range applied to any output in the high-impeda	-0.5	6.5	V	
Vo	Voltage range applied to any output in the high or low	-0.5	V <sub>CC</sub> + 0.5	V	
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
I <sub>O</sub>	Continuous output current			±50	mA
	Continuous current through V <sub>CC</sub> or GND		±100	mA	
$\theta_{JA}$	Package thermal impedance <sup>(4)</sup>		252	°C/W	
T <sub>stg</sub>	Storage temperature range	-65	150	°C	

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of  $V_{CC}$  is provided in the recommended operating conditions table.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

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SCES455B-DECEMBER 2003-REVISED JUNE 2006

## Recommended Operating Conditions<sup>(1)</sup>

			MIN	MAX	UNIT
	Current under se	Operating	1.65	5.5	V
V <sub>CC</sub>	Supply voltage	Data retention only	1.5		V
		V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65  imes V_{CC}$		
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7		V
V <sub>IH</sub>	High-level input voltage	$V_{CC} = 3 V \text{ to } 3.6 V$	2		V
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	$0.7  imes V_{CC}$		
		V <sub>CC</sub> = 1.65 V to 1.95 V		$0.35 \times V_{\text{CC}}$	
.,		V <sub>CC</sub> = 2.3 V to 2.7 V		0.7	V
V <sub>IL</sub>	Low-level input voltage	$V_{CC} = 3 V \text{ to } 3.6 V$		0.8	V
		$V_{CC} = 4.5 V \text{ to } 5.5 V$		$0.3  imes V_{CC}$	
VI	Input voltage	i	0	5.5	V
Vo	Output voltage		0	V <sub>CC</sub>	V
		V <sub>CC</sub> = 1.65 V		-4	
		V <sub>CC</sub> = 2.3 V		-8	
I <sub>ОН</sub>	High-level output current	N 0.11		-16	mA
		$V_{CC} = 3 V$		-24	
		V <sub>CC</sub> = 4.5 V		-32	
		V <sub>CC</sub> = 1.65 V		4	
		V <sub>CC</sub> = 2.3 V		8	
I <sub>OL</sub>	Low-level output current	N 0.11		16	mA
		$V_{CC} = 3 V$		24	
		V <sub>CC</sub> = 4.5 V		32	
		$V_{CC}$ = 1.8 V ± 0.15 V, 2.5 V ± 0.2 V		20	
Δt/Δv	Input transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		10	ns/\
		$V_{CC}$ = 5 V ± 0.5 V		5	
<del>.</del>	On exercise of the end of the terms and the	· · · · · · · · · · · · · · · · · · ·	-40	85	•••
Τ <sub>Α</sub>	A Operating free-air temperature		-55	125	°C

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## SN74LVC1G125-EP SINGLE BUS BUFFER GATE WITH 3-STATE OUTPUT

#### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS	V	<b>40</b> °	C to 85°C		<b>-55</b> °	C to 125°C			
PARAMETER	TEST CONDITIONS	V <sub>cc</sub>	MIN	TYP <sup>(1)</sup>	MAX	MIN	TYP <sup>(1)</sup>	MAX	UNIT	
	I <sub>OH</sub> = -100 μA	1.65 V to 5.5 V	V <sub>CC</sub> – 0.1			V <sub>CC</sub> – 0.1				
	$I_{OH} = -4 \text{ mA}$	1.65 V	1.2			1.2				
M	I <sub>OH</sub> = -8 mA	2.3 V	1.9			1.9			V	
V <sub>OH</sub>	I <sub>OH</sub> = -16 mA	- 3 V	2.4			2.4			v	
	I <sub>OH</sub> = -24 mA	- 3V	2.3			2.3				
	I <sub>OH</sub> = -32 mA	4.5 V	3.8			3.8				
	I <sub>OL</sub> = 100 μA	1.65 V to 5.5 V			0.1			0.1		
	$I_{OL} = 4 \text{ mA}$	1.65 V			0.45			0.45		
M	I <sub>OL</sub> = 8 mA	2.3 V			0.3			0.3	V	
V <sub>OL</sub>	I <sub>OL</sub> = 16 mA	- 3 V			0.4			0.4	v	
	I <sub>OL</sub> = 24 mA	- 3V			0.55			0.60		
	I <sub>OL</sub> = 32 mA	4.5 V		0.55			0.60			
I <sub>I</sub> A or OE inputs	$V_{I} = 5.5 V \text{ or GND}$	0 V to 5.5 V			±5			±5	μA	
I <sub>off</sub>	$V_1 \text{ or } V_0 = 5.5 \text{ V}$	0			±10			±10	μΑ	
I <sub>OZ</sub>	$V_0 = 0$ to 5.5 V	3.6 V			10			10	μΑ	
I <sub>CC</sub>	$V_{I} = 5.5 V \text{ or GND},$ $I_{O} = 0$	1.65 V to 5.5 V			10			10	μA	
$\Delta I_{CC}$	One input at $V_{CC} - 0.6 V$ , Other inputs at $V_{CC}$ or GND	3 V to 5.5 V			500			500	μA	
Ci	$V_{I} = V_{CC}$ or GND	3.3 V		4			4		pF	

(1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

#### **Switching Characteristics**

over recommended operating free-air temperature range of  $-40^{\circ}$ C to  $85^{\circ}$ C , C<sub>L</sub> = 15 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)		= 1.8 V V <sub>CC</sub> = 2.5 V .15 V ± 0.2 V		$V_{CC} = 3.3 V \\ \pm 0.3 V$		$V_{CC}$ = 5 V ± 0.5 V		UNIT	
	(INFUT)	(001F01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A	Y	1.9	6.9	0.7	4.6	0.6	3.7	0.5	3.4	ns

#### **Switching Characteristics**

over recommended operating free-air temperature range of  $-40^{\circ}$ C to  $85^{\circ}$ C, C<sub>L</sub> = 30 pF or 50 pF (unless otherwise noted) (see Figure 2)

		V <sub>CC</sub> = ± 0.1			V <sub>CC</sub> = 2.5 V ± 0.2 V		$\begin{array}{c} {\sf V}_{\sf CC} = 3.3 \ {\sf V} \\ \pm \ 0.3 \ {\sf V} \end{array}$		$V_{CC}$ = 5 V ± 0.5 V		
	(INPUT)	(001901)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	А	Y	2.8	9	1.2	5.5	1	4.5	1	4	ns
t <sub>en</sub>	OE	Y	3.3	10.1	1.5	6.6	1	5.3	1	5	ns
t <sub>dis</sub>	OE	Y	1.3	9.2	1	5	1	5	1	4.2	ns

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#### **Switching Characteristics**

over recommended operating free-air temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 3 ± 0.3	3.3 V V	V <sub>CC</sub> = ± 0.5	UNIT	
	(INPUT)	(001201)	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	А	Y	1	4.9	1	4	ns
t <sub>en</sub>	OE	Y	1	5.8	1	5	ns
t <sub>dis</sub>	OE	Y	1	5	1	4.2	ns

#### **Operating Characteristics**

 $T_A = 25^{\circ}C$ 

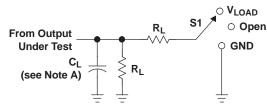
	PARAMET	ER	TEST CONDITIONS	V <sub>CC</sub> = 1.8 V TYP	V <sub>CC</sub> = 2.5 V TYP	V <sub>CC</sub> = 3.3 V TYP	V <sub>CC</sub> = 5 V TYP	UNIT
C	Power dissipation	Outputs enabled	f = 10 MHz	18	18	19	21	۶
Cpd	capacitance	Outputs disabled		2	2	2	4	рг

### SN74LVC1G125-EP SINGLE BUS BUFFER GATE WITH 3-STATE OUTPUT sc產時個時代和1001+255/05ED/供附前/2006



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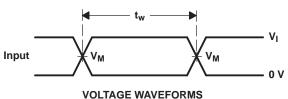
#### PARAMETER MEASUREMENT INFORMATION



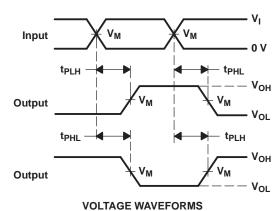
TEST	S1
t <sub>PLH</sub> /t <sub>PHL</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	V <sub>LOAD</sub>
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

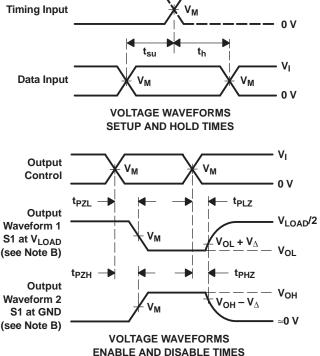
LOAD CIRCUIT

N	INF	PUTS			•	-	
V <sub>CC</sub>	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	V <sub>LOAD</sub>	CL	RL	$V_{\Delta}$
$\textbf{1.8 V} \pm \textbf{0.15 V}$	V <sub>CC</sub>	≤2 ns	V <sub>CC</sub> /2	$2 \times V_{CC}$	15 pF	<b>1 Μ</b> Ω	0.15 V
$\textbf{2.5 V} \pm \textbf{0.2 V}$	V <sub>CC</sub>	≤2 ns	V <sub>CC</sub> /2	$2 \times V_{CC}$	15 pF	1 MΩ	0.15 V
3.3 V $\pm$ 0.3 V	3 V	≤2.5 ns	1.5 V	6 V	15 pF	1 MΩ	0.3 V
5 V $\pm$ 0.5 V	V <sub>CC</sub>	≤2.5 ns	V <sub>CC</sub> /2	$2 \times V_{CC}$	15 pF	<b>1 Μ</b> Ω	0.3 V



VOLTAGE WAVEFORMS PULSE DURATION





#### ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

NOTES: A.  $C_{\text{L}}$  includes probe and jig capacitance.

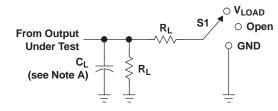
**PROPAGATION DELAY TIMES** 

INVERTING AND NONINVERTING OUTPUTS

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z\_O = 50  $\Omega$ .
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 1. Load Circuit and Voltage Waveforms

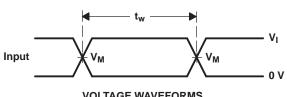
#### PARAMETER MEASUREMENT INFORMATION



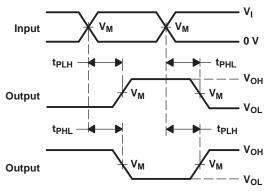
TEST	S1
t <sub>PLH</sub> /t <sub>PHL</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	V <sub>LOAD</sub>
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

LOAD	CIRCUIT	

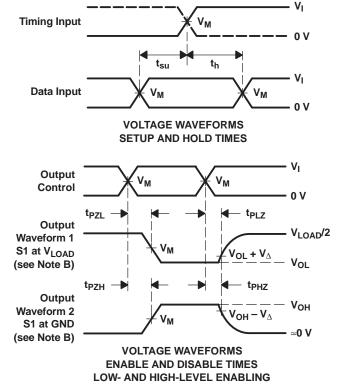
N	INPUTS			N	•		N	
V <sub>CC</sub>	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	V <sub>LOAD</sub>	CL	RL	$V_{\Delta}$	
$\textbf{1.8 V} \pm \textbf{0.15 V}$	V <sub>CC</sub>	≤2 ns	V <sub>CC</sub> /2	$2 \times V_{CC}$	30 pF	<b>1 k</b> Ω	0.15 V	
$\textbf{2.5 V} \pm \textbf{0.2 V}$	V <sub>CC</sub>	≤2 ns	V <sub>CC</sub> /2	$2 \times V_{CC}$	30 pF	<b>500</b> Ω	0.15 V	
3.3 V $\pm$ 0.3 V	3 V	≤2.5 ns	1.5 V	6 V	50 pF	<b>500</b> Ω	0.3 V	
5 V $\pm$ 0.5 V	V <sub>CC</sub>	≤2.5 ns	V <sub>CC</sub> /2	$2 \times V_{CC}$	50 pF	<b>500</b> Ω	0.3 V	



**VOLTAGE WAVEFORMS** PULSE DURATION







### INVERTING AND NONINVERTING OUTPUTS

- NOTES: A. CL includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ .
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
  - G. t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>pd</sub>.
  - H. All parameters and waveforms are not applicable to all devices.

#### Figure 2. Load Circuit and Voltage Waveforms

#### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
CLVC1G125IDCKREP	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CLVC1G125MDCKREP	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CLVC1G125MDCKREPG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/04735-01XE	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/04735-02XE	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD**: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN74LVC1G125-EP :

Catalog: SN74LVC1G125

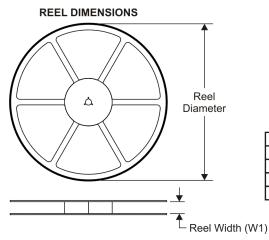
Automotive: SN74LVC1G125-Q1

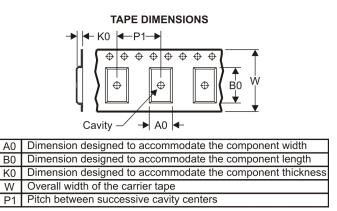
NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects

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### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CLVC1G125IDCKREP	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
CLVC1G125MDCKREP	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3



## PACKAGE MATERIALS INFORMATION

20-Jul-2010



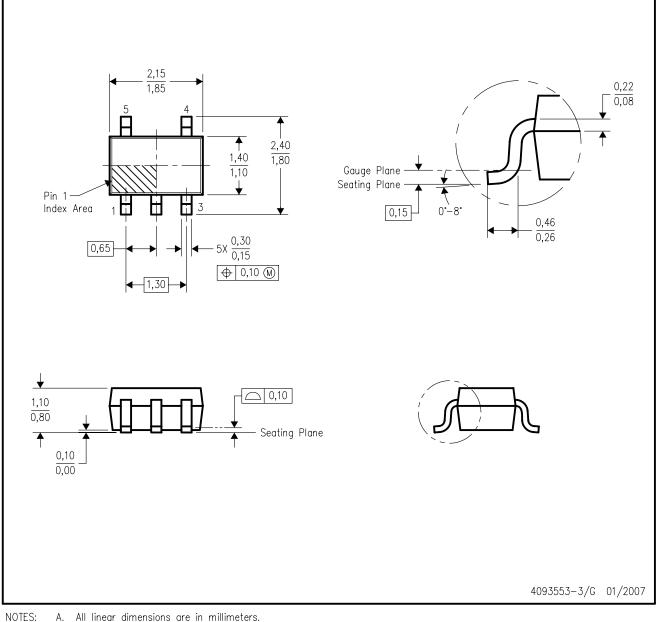
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CLVC1G125IDCKREP	SC70	DCK	5	3000	203.0	203.0	35.0
CLVC1G125MDCKREP	SC70	DCK	5	3000	203.0	203.0	35.0

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## DCK (R-PDSO-G5)

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Falls within JEDEC MO-203 variation AA.



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